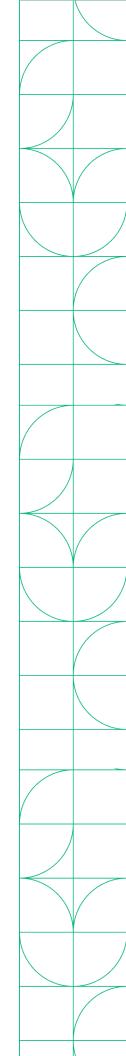


# PXIe-MIO5101 Bundle

Expandable PXI bundle based on PXIe-6363 MIO DAQ, 32 AI Ch, 48 DIO Ch, 4 AO Ch

Specifications PXIe-1083 and PXIe-6363

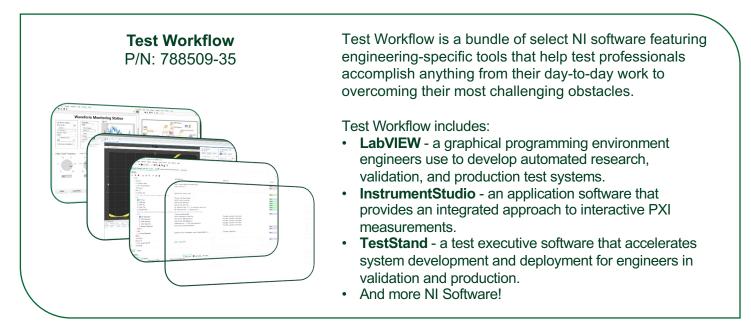


## PXI MIO Bundle

#### In the Box



#### **Recommended Software**



#### Table of Contents

This document combines the PDFs of this bundle together. The page numbers in the table of contents correspond to the page number of PDF the component's documentation begins.

PXIe-1083 Specifications	3
PXIe-6363 Specifications	16

# PXIe-1083 Specifications





# PXIe-1083 Specifications

This document contains specifications for the PXIe-1083 chassis.

## Electrical

The following section provides information about the PXIe-1083 AC input and DC output.

## AC Input

Input rating	100 VAC to 240 VAC, 50 Hz/60 Hz, 6 A to 3 A
Operating voltage range <sup>1</sup>	90 VAC to 264 VAC
Nominal input frequency	50 Hz/60 Hz
Operating frequency range <sup>1</sup>	47 Hz to 63 Hz
Efficiency	78% typical
Over-current protection	Internal fuse in line
Main power disconnect	The AC power cable provides main power disconnect. Do not position the equipment so that it is difficult to disconnect the power cord. The front-panel power switch causes the internal chassis power supply to provide DC power to the PXI Express backplane.



Caution Disconnect power cord to completely remove power.

## DC Output

#### DC output characteristics of the PXIe-1083.

Voltage Rail	Maximum Current	Load Regulation	Maximum Ripple and Noise (20 MHz BW)
+5V_AUX	1.0 A	±5%	50 mVpp
+12 V	30.1 A	±5%	120 mVpp
+5 V	25.1 A	±5%	50 mVpp
+3.3 V	30.7 A	±5%	50 mVpp
-12 V	0.75 A	±5%	120 mVpp

Maximum total available power for the PXIe-1083 is 293 W.

The maximum combined power available on +3.3 V and +5 V is 180 W.

The maximum power available for each Thunderbolt port is 15 W (5 V/3 A).

#### Table 1. Backplane Slot Current Capacity

Slot	+5 V	V (I/O)	+3.3 V	+12 V	-12 V	5 V <sub>AUX</sub>
Hybrid Peripheral Slot with PXI-5 Peripheral	-	-	3 A	6 A	-	1 A
Hybrid Peripheral Slot with PXI-1 Peripheral	6 A	5 A	6 A	1 A	1 A	-

**Note** PCI V(I/O) pins in Hybrid Peripheral Slots are connected to +5 V.

Note The maximum power dissipated in a peripheral slot should not exceed 58 W. Refer to the **Operating Environment** section for ambient temperature considerations at 58 W.

Over-current protection	All outputs are protected from short circuit and overload, they recover and return to regulation when the overload is removed and the power is cycled.
Over-voltage protection	+3.3 V clamped at 3.7 V to 4.3 V, +5 V clamped at 5.7 V to 6.5 V, +12 V clamped at 13.4 V to 15.6 V

## Chassis Cooling

Module cooling	Forced air circulation (positive pressurization) through one 150 CFM fan
Module slot airflow direction	Bottom of module to top of module
Module intake	Bottom of chassis
Module exhaust	Top, right side of chassis
Slot cooling capacity	58 W; slot 6 supports 58 W cooling with high fan mode
Power supply cooling	Forced air circulation through integrated fans
Power supply intake	Front and left side chassis
Power supply exhaust	Rear of chassis
Minimum chassis cooling cl	earances
Above	44.45 mm (1.75 in.)
Rear	44.45 mm (1.75 in.)
Sides	44.45 mm (1.75 in.)
Below	
Rack	44.45 mm (1.75 in.)
Desktop	25.4 mm (1.00 in.)

## Environmental

Maximum altitude	2,000 m (6,560 ft.), 800 mbar (at 25 °C ambient, high fan mode)
Pollution Degree	2

Indoor use only.

## Operating Environment

Ambient temperature range	
When all peripheral modules	0 °C to 50 °C (IEC 60068-2-1 and IEC 60068-2-2.) <sup>2</sup> Meets
require ≤38 W cooling capacity	MIL-PRF-28800F Class 3 low temperature limit and high
per slot	temperature limit.
When any peripheral module	0 °C to 40 °C (IEC 60068-2-1 and IEC 60068-2-2.) <sup>2</sup> Meets
requires >38 W cooling capacity	MIL-PRF-28800F Class 3 low temperature limit and MIL-
per slot	PRF-28800F Class 4 high temperature limit.
Relative humidity range	20% to 80%, noncondensing

## Storage Environment

Ambient temperature range	–40 °C to 71 °C (IEC-60068-2-1 and IEC-60068-2-2.) <sup>[3]</sup> Meets MIL- PRF-28800F Class 3 limits.
Relative humidity range	10% to 95%, noncondensing

## Shock and Vibration

Operational shock	30 g peak, half-sine, 11 ms pulse (IEC-60068-2-27.) <sup>3</sup> Meets MIL- PRF-28800F Class 2 limits.
Operational random vibration	5 to 500 Hz, 0.3 g <sub>rms</sub>
Non-operating vibration	5 to 500 Hz, 2.4 g <sub>rms</sub> (IEC 60068-2-64.) <sup>3</sup> Non-operating test profile exceeds the requirements of MIL-PRF-28800F, Class 3.

## Acoustic Emissions

### Sound Pressure Level (at Operator Position)

(Tested in accordance with ISO 7779. Meets MIL-PRF-28800F requirements.)

38 W Profile	
Auto fan (up to 30 °C ambient)	33.7 dBA
High fan	50.8 dBA
58 W Profile	
Auto fan (up to 30 °C ambient)	54.7 dBA
High fan	55.3 dBA

## Sound Power Level

#### 38 W Profile

Auto fan (up to 30 °C ambient)	44.9 dBA
High fan	60.3 dBA
58 W Profile	
Auto fan (up to 30 °C ambient)	63.4 dBA

Note The protection provided by the PXIe-1083 can be impaired if it is used in a manner not described in this document.

## Safety Compliance Standards

This product is designed to meet the requirements of the following electrical equipment safety standards for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA C22.2 No. 61010-1

Note For safety certifications, refer to the product label or the <u>Product</u> <u>Certifications and Declarations</u> section.

## **EMC Guidelines**

This product was tested and complies with the regulatory requirements and limits for electromagnetic compatibility (EMC) stated in the product specifications. These requirements and limits provide reasonable protection against harmful interference when the product is operated in the intended operational electromagnetic environment. This product is intended for use in industrial locations. However, harmful interference may occur in some installations, when the product is connected to a peripheral device or test object, or if the product is used in residential areas. To minimize interference with radio and television reception and prevent unacceptable performance degradation, install and use this product in strict accordance with the instructions in the product documentation.

Furthermore, any changes or modifications to the product not expressly approved by NI could void your authority to operate it under your local regulatory rules.

## **EMC** Notices

Refer to the following notices for cables, accessories, and prevention measures necessary to ensure the specified EMC performance.

## Notice

For EMC declarations and certifications, and additional information, refer to the <u>Product Certifications and Declarations</u> section.

**Notice** Changes or modifications to the product not expressly approved by NI could void your authority to operate the product under your local regulatory rules.

Notice Operate this product only with shielded cables and accessories.

## **Electromagnetic Compatibility Standards**

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326-1 (IEC 61326-1): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions

AS/NZS CISPR 11: Group 1, Class A emissions

**Note** Group 1 equipment (per CISPR 11) is any industrial, scientific, or medical equipment that does not intentionally generate radio frequency energy for the treatment of material or inspection/analysis purposes.



**Note** In Europe, Canada, Australia, and New Zealand (per CISPR 11) Class A equipment is intended for use in nonresidential locations.

# CE Compliance $C \in$

This product meets the essential requirements of applicable European Directives, as follows:

- 2014/35/EU; Low-Voltage Directive (safety)
- 2014/30/EU; Electromagnetic Compatibility Directive (EMC)
- 2011/65/EU; Restriction of Hazardous Substances (RoHS)

## **Product Certifications and Declarations**

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for NI products, visit <u>ni.com/product-certifications</u>, search by model number, and click the appropriate link.

## **Environmental Management**

NI is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial to the environment and to NI customers.

For additional environmental information, refer to the **Engineering a Healthy Planet** web page at <u>ni.com/environment</u>. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

## EU and UK Customers

• A Waste Electrical and Electronic Equipment (WEEE)—At the end of the product life cycle, all NI products must be disposed of according to local laws and regulations. For more information about how to recycle NI products in your region, visit <u>ni.com/environment/weee</u>.

## 电子信息产品污染控制管理办法(中国 RoHS)

• ◎ ◎ ● 中国 RoHS— NI 符合中国电子信息产品中限制使用某些有害物 质指令(RoHS)。关于 NI 中国 RoHS 合规性信息,请登录 ni.com/environment/ rohs\_china。(For information about China RoHS compliance, go to ni.com/ environment/rohs\_china.)

## Backplane

Size	3U-sized; 5 peripheral slots. Compliant with IEEE 1101.10 mechanical packaging. PXI Express Specification compliant. Accepts both PXI Express and CompactPCI (PICMG 2.0 R 3.0) 3U modules.
Backplane bare-board material	UL 94 V-0 Recognized
Backplane connectors	Conforms to IEC 917 and IEC 1076-4-101, UL 94 V-0 rated

## System Synchronization Clocks

#### 10 MHz System Reference Clock: PXI\_CLK10

Maximum slot-to-slot skew	250 ps
Accuracy	±25 ppm max (guaranteed over the operating temperature range)
Maximum jitter	5 ps RMS phase-jitter (10 Hz–1 MHz range)
Duty-factor	45% to 55%
Unloaded signal swing	3.3 V ±0.3 V



Note For other specifications, refer to the PXI-1 Hardware Specification.

## 100 MHz System Reference Clock: PXIe\_CLK100 and PXIe\_SYNC100

Maximum slot-to-slot skew	100 ps
Accuracy	±25 ppm max (guaranteed over the operating temperature range)
Maximum jitter	3 ps RMS phase-jitter (10 Hz to 12 kHz range), 2 ps RMS phase-jitter (12 kHz to 20 MHz range)
Duty-factor for PXIe_CLK100	45% to 55%
Absolute differential voltage (When terminated with a 50 Ω load to 1.30 V or Thévenin equivalent)	400 mV to 1000 mV



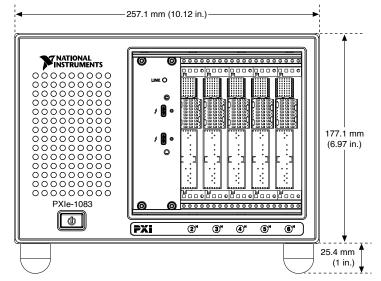
# Note For other specifications, refer to the PXI-5 PXI Express Hardware Specification.

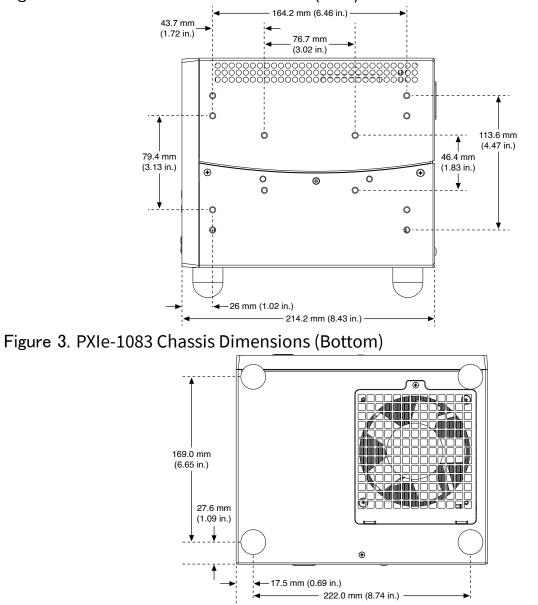
## Mechanical

Standard chassis	dimensions	
Height	177.1 mm (6.97 in.)	
Width	257.1 mm (10.12 in.)	
Depth	214.2 mm (8.43 in.)	
Weight	6.7 kg (14.8 lb)	
Chassis materials	Extruded Aluminum (6063-T5, 6060-T6), Cold Rolled Steel/Stainless Steel, Santoprene, Urethane Foam, PC-ABS, Nylon, Polyethylene	
Finish	Conductive Clear Iridite on Aluminum, Electroplated Nickel on Cold Rolled Steel, Electroplated Zinc on Cold Rolled Steel	

The following figures show the PXIe-1083 chassis dimensions. The holes shown are for installing the optional rack mount kits.

#### Figure 1. PXIe-1083 Chassis Dimensions (Front)





#### Figure 2. PXIe-1083 Chassis Dimensions (Side)

<sup>1</sup> The operating range is guaranteed by design.

<sup>2</sup> This product meets the requirements of the environmental standards for electrical equipment for measurement, control, and laboratory use.

<sup>3</sup> This product meets the requirements of the environmental standards for electrical equipment for measurement, control, and laboratory use.

# PXIe-6363 Specifications



# PXIe-6363 Specifications

## Definitions

**Warranted** specifications describe the performance of a model under stated operating conditions and are covered by the model warranty.

**Characteristics** describe values that are relevant to the use of the model under stated operating conditions but are not covered by the model warranty.

- **Typical** specifications describe the performance met by a majority of models.
- **Nominal** specifications describe an attribute that is based on design, conformance testing, or supplemental testing.

Specifications are **Typical** unless otherwise noted.

## Conditions

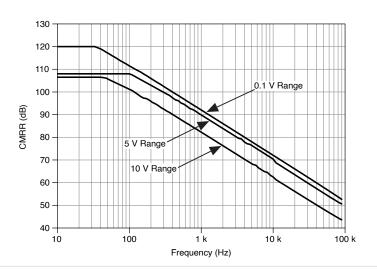
Specifications are valid at 25 °C unless otherwise noted.

## Analog Input

Sample rate	
INL	Refer to <b>AI Absolute Accuracy</b> .
DNL	No missing codes guaranteed
ADC resolution	16 bits
Number of channels	32 single-ended or 16 differential

Single channel maximum	2.00 MSample/s
Multichannel maximum (aggregate)	1.00 MSample/s
Minimum	No minimum
Timing resolution	10 ns
Timing accuracy	50 ppm of sample rate
Input coupling	DC
Input range	±0.1 V, ±0.2 V, ±0.5 V, ±1 V, ±2 V, ±5 V, ±10 V
Maximum working voltage for analog inputs (signal + common mode)	±11 V of AI GND
CMRR (DC to 60 Hz)	100 dB

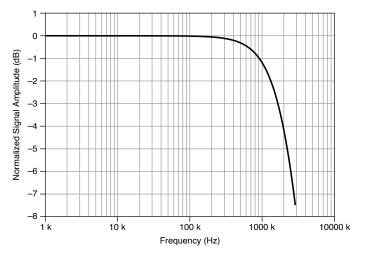
Figure 1. AI <0..31> CMRR



#### Input impedance

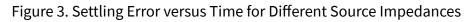
Device on		
AI+ to AI GND	>10 G $\Omega$ in parallel with 100 pF	
AI- to AI GND	>10 G $\Omega$ in parallel with 100 pF	
Device off		
AI+ to AI GND		820 Ω
AI- to AI GND		820 Ω
Input bias current		±100 pA
Crosstalk (at 100 kHz)		
Adjacent channels		-75 dB
Non adjacent channels		-95 dB
Non-adjacent channels		-90 CC-
Small signal bandwidth ( 2	ap)	1.7 MHz
Small signal bandwidth (-3	udj	1.7 МПZ

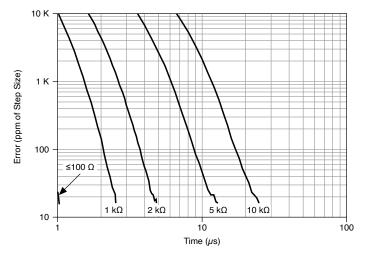
#### Figure 2. AI <0..31> Small Signal Bandwidth



Input FIFO size		2,047 samples		
Scan list memory		4,095 entries		
Data transfers	Data transfers		DMA (scatter-gather), programmed I/O	
Overvoltage protect	ion for all analog input and s	sense ch	annels	
Device on	Device on ±25 V for up to		pins	
Device off ±15 V for up to			pins	
Input current during overvoltage condition ±2			max/Al pin	
Range	±60 ppm of Step (±4 LSB for Full-Scale Step)		±15 ppm of Step (±1 LSB for Full-Scale Step)	
± 10 V, ±5 V, ±2 V, ±1 V	1 μs		1.5 μs	
±0.5 V	1.5 μs	2 µs		
±0.2 V, ±0.1 V	2 μs	8 μs		

Table 1. Settling Time for Multichannel Measurements





## Analog Triggers

Number of triggers	1		
Source	AI <031>, APFI <0,1>		
Functions	Start Trigger, Reference Trigger, Pause Trigger, Sample Clock, Convert Clock, Sample Clock Timebase		
Source level			
AI <031>	±Full scale		
APFI <0,1>	±10 V		
Resolution	16 bits		
Modes	Analog edge triggering, analog edge triggering with hysteresis, analog window triggering		
Bandwidth (-3 dB)			
AI <031>	3.4 MHz		
APFI <0,1>	3.9 MHz		
Accuracy	±1% of range		
APFI <0,1> charact	teristics		
Input impedance	nput impedance 10 kΩ		
Coupling	DC		
Protection			

Power on	±30 V	
Power off	±15 V	

## AI Absolute Accuracy (Warranted)

Nominal Range Positive Full Scale (V)	Nominal Range Negative Full Scale (V)	Residual Gain Error (ppm of Reading)	Residual Offset Error (ppm of Range)	Offset Tempco (ppm of Range/°C)	Random Noise, σ (μVrms)	Absolute Accuracy at Full Scale (μV)
10	-10	48	13	21	315	1,660
5	-5	55	13	21	157	870
2	-2	55	13	24	64	350
1	-1	65	17	27	38	190
0.5	-0.5	68	17	34	27	100
0.2	-0.2	95	27	55	21	53
0.1	-0.1	108	45	90	17	33

Table 2. AI Absolute Accuracy

**Note Absolute Accuracy at Full Scale** is determined using the following assumptions:

- TempChangeFromLastExternalCal = 10 °C
- TempChangeFromLastInternalCal = 1 °C
- NumberOfReadings = 10,000
- CoverageFactor = 3 σ

**Note** Accuracies listed are valid for up to two years from the device external calibration.

Gain tempco	13 ppm/°C

Reference tempco	1 ppm/°C
INL error	60 ppm of range

AI Absolute Accuracy Equation

AbsoluteAccuracy = Reading · (GainError) + Range · (OffsetError) + NoiseUncertainty

 GainError = ResidualGainError + GainTempco · (TempChangeFromLastInternalCal) + ReferenceTempco · (TempChangeFromLastExternalCal)
 OffsetError = ResidualOffsetError + OffsetTempco · (TempChangeFromLastInternalCal) + INLError

```
• NoiseUncertainty =

<u>Random Noise</u> 3

\sqrt{10,000}

for a coverage factor of 3 \sigma and averaging 10,000 points.
```

AI Absolute Accuracy Example

For example, on the 10 V range, the absolute accuracy at full scale is as follows:

• GainError: 48 ppm + 13 ppm  $\cdot$  1 + 1 ppm  $\cdot$  10 = 71 ppm

- OffsetError: 13 ppm + 21 ppm  $\cdot$  1 + 60 ppm = 94 ppm
- NoiseUncertainty:

315 *µ*V

- √<u>10,000</u>
- =9.4 μV
- AbsoluteAccuracy: 10 V · (GainError) + 10 V · (OffsetError) + NoiseUncertainty
- = 1,660 μV

## Analog Output

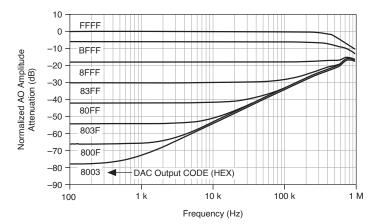
Number of channels	4

DAC resolution	16 bits
DNL	±1 LSB
Monotonicity	16 bit guaranteed
Maximum update rate (simultaneo	us)
1 channel	2.86 MSample/s
2 channels	2.00 MSample/s
3 channels	1.54 MSample/s
4 channels	1.25 MSample/s
Timing accuracy	50 ppm of sample rate
Timing resolution	10 ns
Output range	±10 V, ±5 V, ±external reference on APFI <0,1>
Output coupling	DC
Output impedance	0.2 Ω
Output current drive	±5 mA
Overdrive protection	±25 V
Overdrive current	26 mA
Power-on state	±5 mV

Power-on/off glitch	1.5 V peak for 200 ms
Output FIFO size	8,191 samples shared among channels used
Data transfers	DMA (scatter-gather), programmed I/O
AO waveform modes	Non-periodic waveform, periodic waveform regeneration mode from onboard FIFO, periodic waveform regeneration from host buffer including dynamic update
Settling time, full-scale step 15 ppm (1 LSB)	2 μs
Slew rate	20 V/µs
Glitch energy at midscale transition, ±10 V range	10 nV · s

## **External Reference**

APFI <0,1> characteristics	
Input impedance	10 kΩ
Coupling	DC
Protection, device on	±30 V
Protection, device off	±15 V
Range	±11 V
Slew rate	20 V/µs



#### Figure 4. AO <0..3> External Reference Bandwidth

## AO Absolute Accuracy (Warranted)

Nominal	Nominal	Residual	Gain	Reference	Residual	Offset	INL	Absolute
Range	Range	Gain Error	Tempco	Tempco	Offset	Tempco	Error	Accuracy
Positive	Negative	(ppm of	(ppm/	(ppm/°C)	Error	(ppm of	(ppm of	at Full
Full Scale	Full Scale	Reading)	°C)		(ppm of	Range/	Range)	Scale (µV)
(V)	(V)				Range)	°C)		
10	-10	63	17	1	33	2	64	1,890
5	-5	70	8	1	33	2	64	935

Table 3. AO Absolute Accuracy

**Note Absolute Accuracy at Full Scale** numbers are valid immediately following self calibration and assumes the device is operating within 10 °C of the last external calibration.

**Note** Accuracies listed are valid for up to two years from the device external calibration.

#### AO Absolute Accuracy Equation

AbsoluteAccuracy = OutputValue · (GainError) + Range · (OffsetError)

 GainError = ResidualGainError + GainTempco · (TempChangeFromLastInternalCal) + ReferenceTempco · (TempChangeFromLastExternalCal)

 OffsetError = ResidualOffsetError + OffsetTempco · (TempChangeFromLastInternalCal) + INLError

## Digital I/O/PFI

## **Static Characteristics**

Number of channels	48 total, 32 (P0.<031>),16 (PFI <07>/P1, PFI <815>/P2)
Ground reference	D GND
Direction control	Each terminal individually programmable as input or output
Pull-down resistor	
Typical	50 kΩ
Minimum	20 kΩ
Input voltage protection	±20 V on up to two pins

**Caution** Stresses beyond those listed under the **Input voltage protection** specification may cause permanent damage to the device.

## Waveform Characteristics (Port 0 Only)

Terminals used	Port 0 (P0.<031>)
Port/sample size	Up to 32 bits

Waveform generation (DO) FIFO	2,047 samples
Waveform acquisition (DI) FIFO	255 samples
DI Sample Clock frequency	0 MHz to 10 MHz, system and bus activity dependent
DO Sample Clock frequency	
Regenerate from FIFO 0 MH	z to 10 MHz
Streaming from memory 0 MH	z to 10 MHz, system and bus activity dependent
Data transfers	DMA (scatter-gather), programmed I/O
Digital line filter settings	160 ns, 10.24 μs, 5.12 ms, disable

## PFI/Port1/Port 2 Functionality

Functionality	Static digital input, static digital output, timing input, timing output
Timing output sources	Many AI, AO, counter, DI, DO timing signals
Debounce filter settings	90 ns, 5.12 $\mu s$ , 2.56 ms, custom interval, disable; programmable high and low transitions; selectable per input

## Recommended Operating Conditions

Input high voltage (V <sub>IH</sub> )		
Minimum	2.2 V	
Maximum	5.25 V	

Input low voltage (V <sub>IL</sub> )		
Minimum	0 V	
Maximum	0.8 V	
Output high current (I <sub>OH</sub> )		
P0.<031>	-24 mA maximum	
PFI <015>/P1/P2	-16 mA maximum	
Output low current (I <sub>OL</sub> )		
P0.<031>	24 mA maximum	
PFI <015>/P1/P2	16 mA maximum	

## Digital I/O Characteristics

Positive-going threshold (VT+)	2.2 V maximum
Negative-going threshold (VT-)	0.8 V minimum
Delta VT hysteresis (VT+ - VT-)	0.2 V minimum
I <sub>IL</sub> input low current (V <sub>IN</sub> = 0 V)	-10 μA maximum
I <sub>IH</sub> input high current (V <sub>IN</sub> = 5 V)	250 μA maximum

Figure 5. P0.<0..31>: I<sub>OH</sub> versus V<sub>OH</sub>

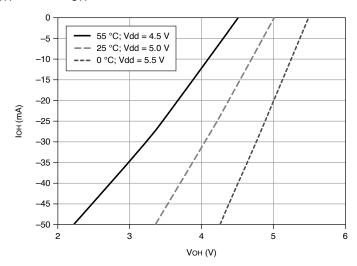


Figure 6. P0.<0..31>: I<sub>OL</sub> versus V<sub>OL</sub>

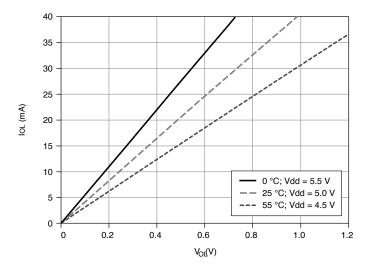


Figure 7. PFI <0..15>/P1/P2: I<sub>OH</sub> versus V<sub>OH</sub>

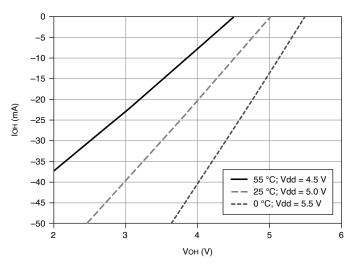
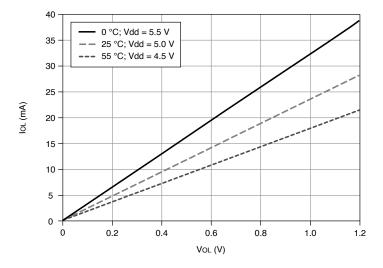


Figure 8. PFI <0..15>/P1/P2: I<sub>OL</sub> versus V<sub>OL</sub>



## General-Purpose Counters

Number of counter/timers	4
Resolution	32 bits
Counter measurements	Edge counting, pulse, pulse width, semi-period, period, two-edge separation

Position measurements	X1, X2, X4 quadrature encoding with Channel Z reloading; two- pulse encoding
Output applications	Pulse, pulse train with dynamic updates, frequency division, equivalent time sampling
Internal base clocks	100 MHz, 20 MHz, 100 kHz
External base clock frequency	0 MHz to 25 MHz; 0 MHz to 100 MHz on PXIe_DSTAR <a,b></a,b>
Base clock accuracy	50 ppm
Inputs	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down, Sample Clock
Routing options for inputs	Any PFI, PXIe_DSTAR <a,b>, PXI_TRIG, PXI_STAR, analog trigger, many internal signals</a,b>
FIFO	127 samples per counter
Data transfers	Dedicated scatter-gather DMA controller for each counter/timer, programmed I/O

## Frequency Generator

Number of channels	1
Base clocks	20 MHz, 10 MHz, 100 kHz
Divisors	1 to 16
Base clock accuracy	50 ppm

## Phase-Locked Loop (PLL)

Number of PLLs	1	
	k locking frequency	
PXIe_DSTAR <a,< td=""><td>D~</td><td>10 MHz, 20 MHz, 100 MHz</td></a,<>	D~	10 MHz, 20 MHz, 100 MHz
PXI_STAR		10 MHz, 20 MHz
PXIe_CLK100		100 MHz
PXI_TRIG <07>		10 MHz, 20 MHz
PFI <015>		10 MHz, 20 MHz
Output of PLL	Output of PLL 100 MHz Timebase; other signals derived from 100 MHz Timebase including 20 MHz and 100 kHz Timebases	

## External Digital Triggers

Source	Any PFI, PXIe_DSTAR <a,b>, PXI_TRIG,PXI_STAR</a,b>
Polarity	Software-selectable for most signals
Analog input function	Start Trigger, Reference Trigger, Pause Trigger, Sample Clock, Convert Clock, Sample Clock Timebase
Analog output function	Start Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase
Counter/timer functions	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down, Sample Clock

Digital waveform generation (DO) function	Start Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase
Digital waveform acquisition	Start Trigger, Reference Trigger, Pause Trigger, Sample Clock,
(DI) function	Sample Clock Timebase

## Device-to-Device Trigger Bus

Input source	PXI_TRIG <07>, PXI_STAR, PXIe_DSTAR <a,b></a,b>
Output destination	PXI_TRIG <07>, PXIe_DSTARC
Output selections	10 MHz Clock; frequency generator output; many internal signals
Debounce filter settings	90 ns, 5.12 $\mu s$ , 2.56 ms, custom interval, disable; programmable high and low transitions; selectable per input

## **Bus Interface**

Form factor	x1 PXI Express peripheral module, specification rev 1.0 compliant
Slot compatibility	x1 and x4 PXI Express or PXI Express hybrid slots
DMA channels	8, can be used for analog input, analog output, digital input, digital output, counter/timer 0, counter/timer 1, counter/timer 2, counter/timer 3

## **Power Requirements**

**Caution** The protection provided by the device can be impaired if the device is used in a manner not described in the **X Series User Manual**.

+3.3 V	1.6 W
+12 V	19.8 W

## **Current Limits**

**Caution** Exceeding the current limits may cause unpredictable device behavior.

+5 V terminal (connector 0)	1 A maximum <sup>[1]</sup>
+5 V terminal (connector 1)	1 A maximum <sup>[1]</sup>
P0/PFI/P1/P2 and +5 V terminals combined	2 A maximum

## **Physical Characteristics**

Printed circuit board	dimensions	Standard 3U PXI
Weight		215 g (7.6 oz)
I/O connectors Module connector 68-Pos Right Angle Dual Stack PCB-Mount VHDCI (Receptacle)		
Cable connector	68-Pos Offset IDC Cable Connector (Plug) (SHC68-*)	

**Note** For more information about the connectors used for DAQ devices, refer to the document, **NI DAQ Device Custom Cables, Replacement** 

**Connectors, and Screws**, by going to <u>ni.com/info</u> and entering the Info Code rdspmb.

## Calibration

Recommended warm-up time	15 minutes
Calibration interval	2 years

## Maximum Working Voltage

**Maximum working voltage** refers to the signal voltage plus the common-mode voltage.

Channel to earth	11 V, Measurement Category I

Measurement Category I is for measurements performed on circuits not directly connected to the electrical distribution system referred to as **MAINS** voltage. MAINS is a hazardous live electrical supply system that powers equipment. This category is for measurements of voltages from specially protected secondary circuits. Such voltage measurements include signal levels, special equipment, limited-energy parts of equipment, circuits powered by regulated low-voltage sources, and electronics.

**Caution** Do not connect the system to signals or use for measurements within Measurement Categories II, III, or IV.

**Note** Measurement Categories CAT I and CAT O are equivalent. These test and measurement circuits are for other circuits not intended for direct connection to the MAINS building installations of Measurement Categories CAT II, CAT III, or CAT IV.

## Environmental

## Temperature and Humidity

Temperature		
Operating	0 °C to 55 °C	
Storage	-40 °C to 71 °C	
Humidity		
Operating	10% to 90% RH, noncondensing	
Storage	5% to 95% RH, noncondensing	
Pollution Degree		2
Maximum altitude		2,000 m

Indoor use only.

## Shock and Vibration

Refer to the **X Series User Manual** for more information about meeting these specifications.

Operational shock	30 g peak, half-sine, 11 ms pulse	
<b>Random vibration</b> Operating	5 Hz to 500 Hz, 0.3 g <sub>rms</sub>	

Nonoperating

5 Hz to 500 Hz, 2.4 g<sub>rms</sub>

### **Environmental Standards**

This product meets the requirements of the following environmental standards for electrical equipment.

- IEC 60068-2-1 Cold
- IEC 60068-2-2 Dry heat
- IEC 60068-2-27 Operating shock
- IEC 60068-2-64 Random operating vibration
- IEC 60068-2-56 Damp heat (steady state)
- MIL-PRF-28800F
  - Low temperature limits for operation Class 3, for storage Class 3
  - High temperature limits for operation Class 2, for storage Class 3
  - Random vibration for non-operating Class 3
  - Shock for operating Class 2

## Safety Compliance Standards

This product is designed to meet the requirements of the following electrical equipment safety standards for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA C22.2 No. 61010-1

**Note** For safety certifications, refer to the product label or the <u>Product</u> <u>Certifications and Declarations</u> section.

## Electromagnetic Compatibility Standards

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326-1 (IEC 61326-1): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- AS/NZS CISPR 11: Group 1, Class A emissions
- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions

**Note** Group 1 equipment (per CISPR 11) is any industrial, scientific, or medical equipment that does not intentionally generate radio frequency energy for the treatment of material or inspection/analysis purposes.

**Note** In the United States (per FCC 47 CFR), Class A equipment is intended for use in commercial, light-industrial, and heavy-industrial locations. In Europe, Canada, Australia and New Zealand (per CISPR 11) Class A equipment is intended for use only in heavy-industrial locations.

**Notice** For EMC declarations and certifications, and additional information, refer to the <u>Product Certifications and Declarations</u> section.

# CE Compliance C $\epsilon$

This product meets the essential requirements of applicable European Directives, as follows:

- 2014/35/EU; Low-Voltage Directive (safety)
- 2014/30/EU; Electromagnetic Compatibility Directive (EMC)
- 2011/65/EU; Restriction of Hazardous Substances (RoHS)

## Product Certifications and Declarations

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for NI products, visit <u>ni.com/product-certifications</u>, search by model number, and click the appropriate link.

## Environmental Management

NI is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial to the environment and to NI customers.

For additional environmental information, refer to the **Engineering a Healthy Planet** web page at <u>ni.com/environment</u>. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

## EU and UK Customers

• At the end of the product life cycle, all NI products must be disposed of according to local laws and regulations. For more information about how to recycle NI products in your region, visit <u>ni.com/environment/weee</u>.

## 电子信息产品污染控制管理办法(中国 RoHS)

• ◎ ◎ 中国 RoHS— NI 符合中国电子信息产品中限制使用某些有害物 质指令(RoHS)。关于 NI 中国 RoHS 合规性信息,请登录 ni.com/environment/ rohs\_china。(For information about China RoHS compliance, go to ni.com/ environment/rohs\_china.)

 $\frac{1}{2}$  Has self-resetting fuse that opens when current exceeds this specification.